

DUAL CHIP STACK METHOD FOR ELECTRO-STATIC DISCHARGE PROTECTION OF INTEGRATED CIRCUITS

Abstract of the Disclosure

Disclosed is an electronic device comprising a semiconductor chip including an integrated circuit having at least one electrostatic discharge sensitive device and a non-semiconductor chip, positioned in close proximity to the semiconductor chip, the non-semiconductor chip having at least one electrostatic discharge protection device. The electrostatic discharge protection device is electrically connected to the electrostatic discharge sensitive device.

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Figures

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